

PATENT ASSIGNMENT COVER SHEET

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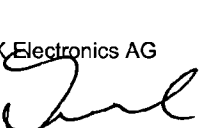
SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TDK ELECTRONICS AG	03/10/2020
RECEIVING PARTY DATA	
Name:	TDK CORPORATION
Street Address:	2-5-1, NIHONBASHI, CHUO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	103-6128
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17079276
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	9727321001
Email:	docketing@slatermatsil.com
Correspondent Name:	SLATER MATSIL, LLP.
Address Line 1:	17950 PRESTON RD. STE 1000
Address Line 4:	DALLAS, TEXAS 75252
ATTORNEY DOCKET NUMBER:	EPC-593-EH
NAME OF SUBMITTER:	SARAH CHAPPELL
SIGNATURE:	/Sarah Chappell/
DATE SIGNED:	03/30/2021
Total Attachments: 1	
source=EPC593EHDeedofAssignmentfromTDK Elect. AG to TDK Corp (file 2nd#page1.tif	

DEED OF ASSIGNMENT

We, **TDK Electronics AG**, a corporation duly organized under the laws of Germany,
of **Rosenheimer Str. 141e, 81671 Munich, Germany**,
state that based on the "MEMS service agreement" we hereby assign the entire rights and
interests in respect of the
PCT applications listed below and all other rights and interests relating thereto
to **TDK Corporation**
of **2-5-1, Nihonbashi, Chuo-ku, 103-6128 Tokyo, Japan**
on _____.

Patent applications:

DE 102019123077.2 (EHF reference: P2019,1024 DE E)
DE 102019126025.6 (EHF reference: P2019,1135 DE E)
DE 102019126024.8 (EHF reference: P2019,1138 DE E)
DE 102019127748.5 (EHF reference: P2019,1212 DE E)
DE 102019128767.7 (EHF reference: P2019,1291 DE E)
DE 102019130209.9 (EHF reference: P2019,1335 DE E)
DE 102019130755.4 (EHF reference: P2019,1373 DE E)
DE 102019131824.6 (EHF reference: P2019,1414 DE E)
DE 102020102493.2 (EHF reference: P2020,0106 DE E)

Signature of the registered applicant / owner or representative	
TDK Electronics AG	
	
Dr. Anton Leidl	Peter Hofmeister
Vice President MEMS Microphones	Corporate Senior Vice President
Date: <u>10.3.20</u>	Date: <u>13.3.2020</u>

Signature of the assignee or representative
TDK Corporation

Osamu Hikita
General Manager of Intellectual Property
Date: <u>March 25, 2020</u>